



富捷科技
FOJAN

Product Datasheet

产品规格说明书

FPL Series High Power Low-ohmic Thick Film Chip Resistor

高功率低阻厚膜片式电阻器

安徽省富捷电子科技有限公司

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高功率低阻厚膜片式电阻器 High Power Low-ohmic Thick Film Chip Resistor



■ 特点 (Features)

- 体积小, 重量轻 - Miniature and light weight
- 电性能稳定, 可靠度高 - Stable electrical capability and high Reliability
- 符合 RoHS 指令要求 - Compliant with RoHS directive
- 符合无卤素要求 - Halogen free requirement
- 高功率低阻值 - High Power Low-ohmic

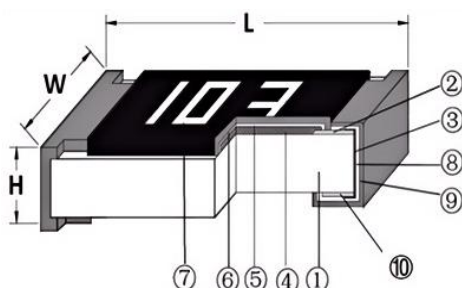
■ 应用 (Application)

- 广泛应用于开关电源、音响设备的过电流保护、电压调节器、电源转换器、充电器、汽车引擎控制器、便携式设备等。
Switching Power Supply Over Current Protection in Audio Application Voltage Regulation Module (VRM) DC-DC Converter Charger Automotive Engine Control Portable Devices etc.

■ 产品料号 (Parts Number Explanation) 示例: FPL1206FR100TS

F 公司	PL 产品别	1206 尺寸	F 公差	R100 字码	T 包装别	S 端电极	特殊码
FOJAN	PL: High Power Low-ohmic Others series refer to Catalogue	0402	F:±1%	0603: 3-digits	T: 7 inch reel	S: Sn	Blank:
		0603	J:±5%	R10=100mR	Q:10 inch reel	C: Cu	none
		0805		R50=500mR	R:13 inch reel	A: Au	
		1206		02Z=102mR	B: Bulk		
		1210		0805-2512:			
		1218		4-digits			
		1812		R100=100mR			
		2010		R500=500mR			
		2512					
Company	Product Type	Size	Tolerance	Resistance	Packaging	Termination	Special Case

■ 电阻结构 (Construction)



NO.	结构 Construction	主要材料 Major material
1	陶瓷基板 Ceramic substrate	三氧化二铝 Al_2O_3
2	银电极 Conductive layer(Top)	银 Ag
3	侧电极 Side conductive layer	镍铬合金 NiCr
4	阻体层 Resistive layer	氧化钌 RuO_2
5	内保护层 Inner protective layer	玻璃 Glass
6	外保护层 Outer Protective layer	环氧树脂 Epoxy
7	文字 Marking	环氧树脂 Epoxy
8	镍电极 Ni plating layer	镍 Ni
9	镍电极 Ni plating layer	镍 Ni
10	银电极 Conductive layer(Back)	银 Ag

■ 尺寸 (Dimension):

尺寸 Dimension							单位 (unit) : mm
型别 (Type)		L	W	H	T1	T2	
英制	公制						
0402	1005	1.00 ± 0.05	0.50 ± 0.05	0.35 ± 0.05	0.20 ± 0.10	0.25 ± 0.10	
0603	1608	1.60 ± 0.10	0.80 ± 0.10	0.45 ± 0.10	0.25 ± 0.15	0.25 ± 0.15	
0805	2012	2.00 ± 0.10	1.25 ± 0.10	0.50 ± 0.10	0.35 ± 0.20	0.40 ± 0.20	
1206	3216	3.10 ± 0.10	1.60 ± 0.10	0.55 ± 0.10	0.45 ± 0.20	0.45 ± 0.20	
1210	3225	3.10 ± 0.10	2.50 ± 0.15	0.55 ± 0.10	0.45 ± 0.15	0.50 ± 0.20	
1218	3245	3.10 ± 0.10	4.60 ± 0.10	0.55 ± 0.10	0.45 ± 0.20	0.40 ± 0.20	
1812	4532	4.50 ± 0.20	3.10 ± 0.20	0.55 ± 0.10	0.55 ± 0.20	0.70 ± 0.20	
2010	5025	5.00 ± 0.10	2.50 ± 0.15	0.55 ± 0.10	0.45 ± 0.15	0.50 ± 0.20	
2512	6432	6.35 ± 0.10	3.10 ± 0.15	0.55 ± 0.10	0.60 ± 0.20	0.90 ± 0.20	

■ 电气特性 (Electrical characteristics)

型别 Type	70°C 下额定功率 Rated Power at 70°C	最大工作电压 Max Working Voltage	最大过负荷电压 Max Overload Voltage	绝缘耐压 Dielectric Withstanding Voltage
0402	1/10W	50V	100V	300V
0603	1/5W	75V	150V	300V
0805	1/4W	150V	300V	500V
1206	1/2W	200V	400V	500V
1210	3/4W	200V	400V	500V
1812	1W	200V	500V	500V
2010	1W	200V	400V	500V
2512	2W	200V	400V	500V

备注 (Remark) : 额定电压计算公式 (The rated voltage is calculated by the following formula) :

$$E = \sqrt{RP}$$

E: 额定电压 (Rated Voltage) (V)

P: 额定功率 (Rated Power) (W)

R: 电阻阻值 (Resistance) (ohm)

如果计算出的电压超过此型别的最大工作电压, 则此型别的最大工作电压为此电阻的额定电压。

In case the value calculated by the formula exceed the maximum working voltage as above table 8, the maximum working voltage shall be regarded as rated voltage.

■ 功率衰减曲线 (Derating Curve)

使用温度范围 Temperature usage range	-55°C~+155°C								
说明 Describe	周围温度若超过 70°C至 155°C之间,功率可照下图曲线予以修订 If the ambient temperature exceeds 70°C to 155°C, the power can be revised according to the curve in the following figure								
功率衰减曲线图 Power Attenuation Curve	The graph shows the power attenuation curve for the resistor. The y-axis represents the Percent rated load (%) from 0 to 100. The x-axis represents the Ambient temperature (°C) from -55 to 160. The curve is a horizontal line at 100% load from -55°C to 70°C, and then a straight line decreasing to 0% load at 155°C. <table border="1"><caption>Data points for Power Attenuation Curve</caption><thead><tr><th>Ambient temperature (°C)</th><th>Percent rated load (%)</th></tr></thead><tbody><tr><td>-55</td><td>100</td></tr><tr><td>70</td><td>100</td></tr><tr><td>155</td><td>0</td></tr></tbody></table>	Ambient temperature (°C)	Percent rated load (%)	-55	100	70	100	155	0
Ambient temperature (°C)	Percent rated load (%)								
-55	100								
70	100								
155	0								

■ 温度系数 (Temperature Coefficient)

型别 Type	阻值范围 Resistance Range	产品精度和温漂系数 (ppm/°C) Resistance Tolerance and TCR (ppm/°C)		
		±1%	±2%	±5%
0402	$0.1\Omega \leq R < 0.5\Omega$	±800	±800	±800
	$0.5\Omega \leq R < 0.91\Omega$	±400	±400	±400
0603/0805 1206/1210 1812/2010/2512	$0.1\Omega \leq R < 0.5\Omega$	±600	±600	±600
	$0.5\Omega \leq R < 0.91\Omega$	±400	±400	±400

■ 性能 (Performance)

内容 Item	测试方法 Test Methods	测试条件 Test Conditions	规格 Specification
温度系数 Temperature Coefficient	JIS C 5201 4.8	$TCR = (R - R_0) / (t - t_0) R_0 \times 10^6$ (ppm) R_0 : 电阻在室温下的阻值(resistance at room temperature) R : 电阻在 125°C或-55°C下的阻值(resistance at 125°C or -55°C) t_0 : 室温(room temperature) t : 测试温度 (test temperature 125°C or -55°C)	As SEPC
短时间过负荷 Short-time overload	JIS C 5201 4.13	加载 5 倍的额定功率, 时间 5 秒后测量试验前后的阻值变化率。 Applied 5 times of rated power for 5 second. Measure the variation of resistance.	0.5%/1%: ±(1.0%+0.05Ω) 5%: ±(2.0%+0.05Ω)
焊锡性 Solderability	JIS C 5201 4.17	沾助焊剂后浸入锡炉, 锡炉温度 245±5°C, 时间 3±0.5 秒。 Dip the terminal in a flux and then dip into a soldering bath at 245±5°C for 3±0.5sec.	> 95%面积上锡 (> 95% coverage)
抗焊锡热 Resist to soldering heat	JIS C 5201 4.18	沾助焊剂后浸入锡炉, 锡炉温度 260±5°C, 时间 10±0.5 秒, 测量试验前后的阻值变化率。 Dip the terminal in a flux and then dip into a soldering bath at 260±5°C for 10±0.5sec. Measure the variation of resistance.	±(1.00% +0.05Ω)
绝缘电阻 Insulation resistance	JIS C 5201 4.6	电阻本体上加载绝缘耐压 60±5 秒后, 测量绝缘阻抗。 Applied the dielectric withstanding voltage on the center of body for 60±5seconds. Then measure insulation resistance.	> 10GΩ
绝缘耐压 Dielectric withstanding voltage	JIS C 5201 4.7	电阻本体上加载绝缘耐压 60±5 秒。 Applied the dielectric withstanding voltage on the center of body for 60±5seconds.	无击穿、飞弧可见机械性损伤 No evidence of flashover, mechanical damage arcing or insulation breakdown

FPL-Series High Power Low-ohmic
Thick Film Chip Resistor Product Specifications
FPL 系列高功率低阻厚膜片式电阻器规格说明书



内容 Item	测试方法 Test Methods	测试条件 Test Conditions	规格 Specification
温度快速变化 Rapid temperature changes	JIS C 5201 4.19	电阻放入温度循环机中, T1 温度: $-55\pm 3^{\circ}\text{C}$; T2 温度: $155\pm 3^{\circ}\text{C}/125\pm 3^{\circ}\text{C}$, 放置 30 分钟, 共 300 个循环。量测试验前后阻值变化率。 Put specimen in a chamber which temperature can be T1: $-55\pm 3^{\circ}\text{C}$; T2: $155\pm 3^{\circ}\text{C}/125\pm 3^{\circ}\text{C}$, 30min, repeated 300 cycles. Measure the variation of resistance.	0.5%/1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(2.0\%+0.05\Omega)$
温湿循环 Moisture resistance	MIL-STD-202 METHOD 106	25°C~65°C, 90~100%RH, 2.5 小时; 65°C 90~100%RH, 3 小时; 65°C~25°C, 80~100%RH, 2.5 小时, 10 个循环, 试验结束 24±4 小时后进行测试。 25°C~65°C, 90~100%RH, 2.5H; 65°C 90~100%RH, 3H; 65°C~25°C 80~100%RH, 2.5H, 10 cycles, Measurement at 24±4 hours after test conclusion.	0.5%/1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(2.0\%+0.05\Omega)$
端子弯曲 Terminal bending	JIS C 5201 4.33	电阻焊接在测试板上进行弯折, 弯折保持时间 20±1 秒, 1206(含) 以下的尺寸弯曲 5+0.2/0 mm; 1206 以上的尺寸弯曲 2+0.2/0 mm; 量测试验前后阻值变化率 Specimen shall be mounted on test board, then bend the board and maintained for 20±1s. the distance of bending is 5+0.2/0 mm for resistors which size no larger than 1206 or 2+0.2/0 mm which size larger than 1206. Measure the variation of resistance. 测试板 (test board) 压头 (jig) 待测物 Specimen 测试基板 Testing printed circuit board 测试支架 Supporting jig 基板原位置 Position before bend 压头 Jig 印刷电路板 Testing printed circuit board 压伸间距 Distance of bending	$\pm(1.00\% + 0.05\Omega)$

内容 Item	测试方法 Test Methods	测试条件 Test Conditions	规格 Specification
耐湿特性 Humidity	JIS C 5201 4.24	电阻放入恒温恒湿箱, 温度 $40\pm 2^{\circ}\text{C}$, 湿度 90~95 %RH;通电额定电压 1.5 小时, 断电 0.5 小时; 重复通断电至试验时间 1000^{+48}_{-0} 小时. 量测试验前后阻值变化率. Put the specimen in a chamber at $40\pm 2^{\circ}\text{C}$ temperature and 90~95% relative humidity, then applied rated voltage for 1.5H "ON" and 0.5H "OFF" repeatedly till total test time is 1000^{+48}_{-0} H. Measure the variation of resistance.	0.5%、1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(2.0\%+0.05\Omega)$
负荷寿命 Load life	JIS C 5201 4.25.1	电阻放入恒温箱中, 温度 $70\pm 2^{\circ}\text{C}$, ON TIME:1.5H, OFF TIME:0.5H, 通电额定电压 1000^{+24}_{-0} 小时, 量测试验前后阻值变化率. Put the specimen in a chamber at $70\pm 2^{\circ}\text{C}$ temperature, ON TIME:1.5H, OFF TIME:0.5H, and applied rated voltage for 1000^{+24}_{-0} H. Measure the variation of resistance.	0.5%、1%: $\pm(1.0\%+0.05\Omega)$ 5%: $\pm(2.0\%+0.05\Omega)$

■ 本体标识 (Marking on the Resistor's Body)

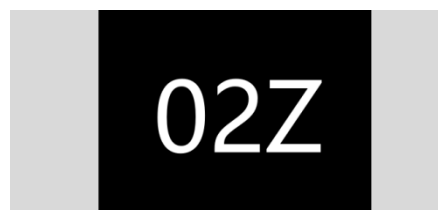
1.0402 因本体太小, 本体上无字码标示

For 0402 size, no marking on the body due to the small size of the resistor

2.0603 规格 (1%&5%) (0603Type) : 3 字码 (3-digits)



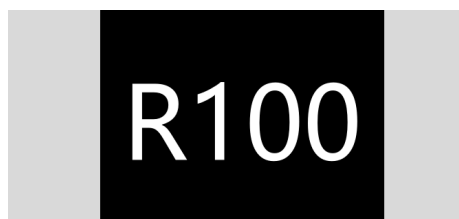
R10=100mΩ



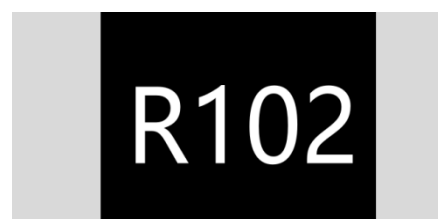
02Z=102mΩ

3.0805/1206/1210/2010/2512/1812 规格 (1%&5%) : 4 字码

0805/1206/1210/2010/2512/1812type (1%&5%) : 4-digits



R100=100mΩ



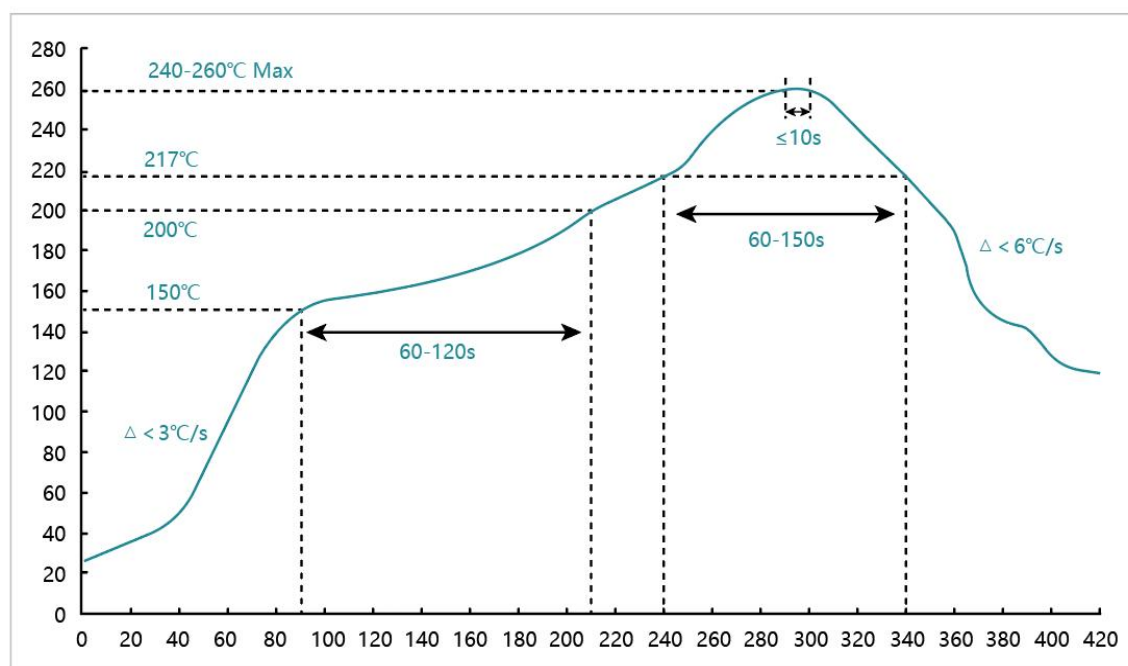
R102=102mΩ

■ 0603±1% E96 系列电阻值代码 Standard E96 Series Resistance Value Code for 0603 ±1% Marking

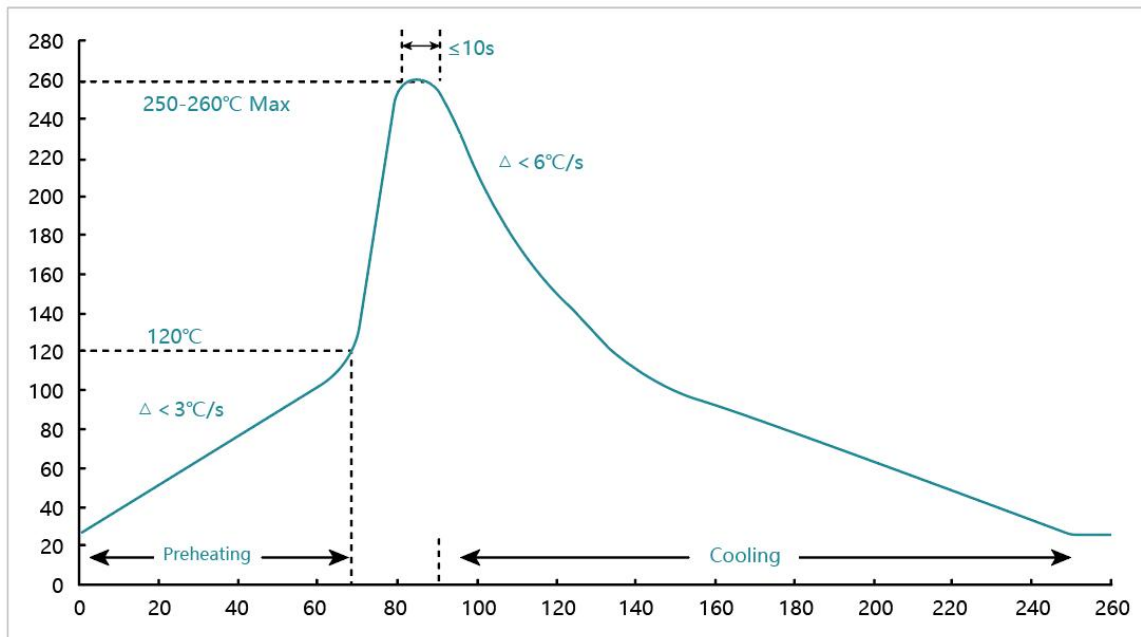
代码 Code	阻值 Value	代码 Code	阻值 Value	代码 Code	阻值 Value	代码 Code	阻值 Value	代码 Code	阻值 Value	代码 Code	阻值 Value
102 mR	02Z	158 mR	20 Z	232 mR	36 Z	332 mR	51 Z	475 mR	66 Z	681 mR	81 Z
105 mR	03 Z	162 mR	21 Z	237 mR	37 Z	340 mR	52 Z	487 mR	67 Z	698 mR	82 Z
107 mR	04 Z	165 mR	22 Z	243 mR	38 Z	348 mR	53 Z	499 mR	68 Z	715 mR	83 Z
113 mR	06 Z	169 mR	23 Z	249 mR	39 Z	357 mR	54 Z	511 mR	69 Z	732 mR	84 Z
115 mR	07 Z	174 mR	24 Z	255 mR	40 Z	365 mR	55 Z	523 mR	70 Z	768 mR	86 Z
118 mR	08 Z	178 mR	25 Z	261 mR	41 Z	374 mR	56 Z	536 mR	71 Z	787 mR	87 Z
121 mR	09 Z	182 mR	26 Z	267 mR	42 Z	383 mR	57 Z	549 mR	72 Z	806 mR	88 Z
124 mR	10 Z	187 mR	27 Z	274 mR	43 Z	392 mR	58 Z	562 mR	73 Z	825 mR	89 Z
127 mR	11 Z	191 mR	28 Z	280 mR	44 Z	402 mR	59 Z	576 mR	74 Z	845 mR	90 Z
133 mR	13 Z	196 mR	29 Z	287 mR	45 Z	412 mR	60 Z	590 mR	75 Z	866 mR	91 Z
137 mR	14 Z	205 mR	31 Z	294 mR	46 Z	422 mR	61 Z	604 mR	76 Z	887 mR	92 Z
140 mR	15 Z	210 mR	32 Z	301 mR	47 Z	432 mR	62 Z	619 mR	77 Z	909 mR	93 Z
143 mR	16 Z	215 mR	33 Z	309 mR	48 Z	442 mR	63 Z	634 mR	78 Z	931 mR	94 Z
147 mR	17 Z	221 mR	34 Z	316 mR	49 Z	453 mR	64 Z	649 mR	79 Z	953 mR	95 Z
154 mR	19 Z	226 mR	35 Z	324 mR	50 Z	464 mR	65 Z	665 mR	80 Z	976 mR	96 Z

■ 焊接 (soldering)

- 建议回流焊曲线 (Recommend reflow soldering profile)



- 建议波峰焊曲线 (Recommend wave soldering profile)



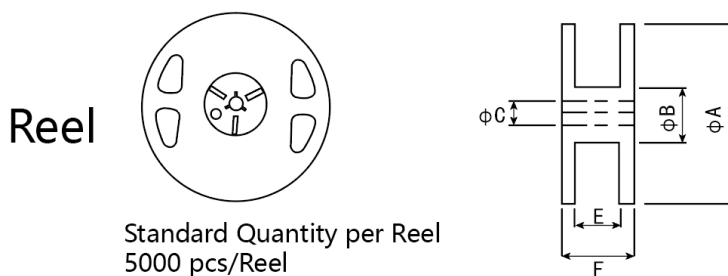
- 手工焊温度 (hand soldering temperature)

烙铁温度 $350 \pm 10^{\circ}\text{C}$ 3 秒之内, 避免烙铁接触电阻本体

The iron temperature is $350 \pm 10^{\circ}\text{C}$, hand soldering time less than 3S. Avoid solder iron tip direct touch the components body

■ 包装规格 (Tapping Specification)

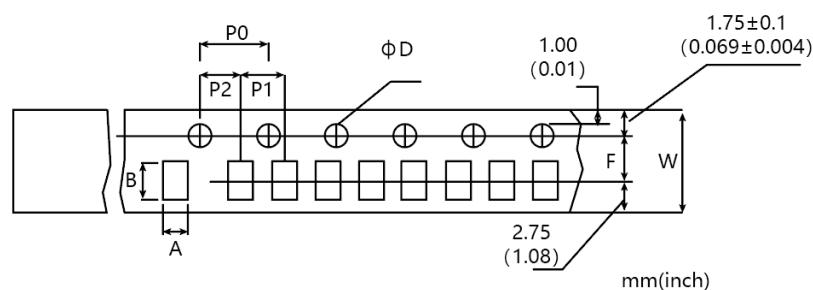
- 卷盘尺寸 (Reel dimension)



Type	Size		Unit	A	B	C	F	W
0402	7"	10K/Reel	mm	178±2.0	60.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
0402	13"	40K/50K Reel	mm	330±2.0	100.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
0603/0805/1206/1210	7"	5K/Reel	mm	178±2.0	60.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
0603/0805/1206	10"	10K/Reel	mm	254±2.0	100.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
0603/0805/1206	13"	20K/Reel	mm	330±2.0	100.0±1.0	13.5±0.5	11.4±0.1	9.00±0.3
1218/1812/2010/2512	7"	4K/Reel	mm	178±2.0	60.0±1.0	13.5±0.5	15.4±1.0	13.0±0.3

-包装尺寸 (packing dimension)

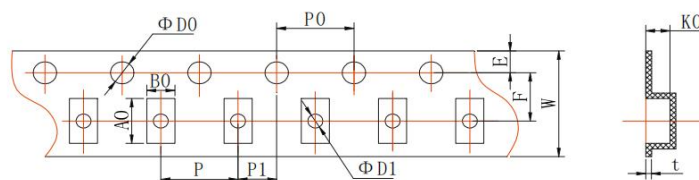
纸带编带 Paper Taping



Unit: mm

Dim	A	B	D	F	P0	P1	P2	W	T
0402	0.65±0.10	1.15±0.10	1.50±0.10	3.50±0.05	4.00±0.10	2.00±0.10	2.00±0.05	8.00±0.20	0.42±0.03
0603	1.10±0.10	1.90±0.10	1.50±0.10	3.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	8.00±0.20	0.60±0.03
0805	1.65±0.20	2.40±0.20	1.50±0.10	3.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	8.00±0.20	0.75±0.05
1206	1.90±0.20	3.50±0.20	1.50±0.10	3.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	8.00±0.20	0.75±0.05
1210	2.80±0.20	3.50±0.20	1.50±0.10	3.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	8.00±0.20	0.75±0.05

塑料带编带 Embossed Taping



Unit: mm

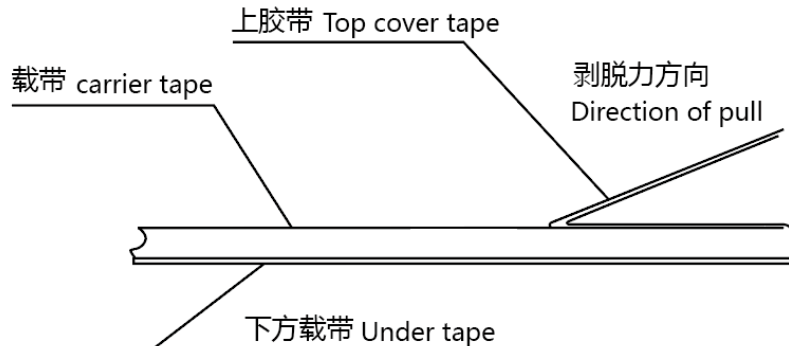
Dim	B0	A0	D0	F	P0	P	P1	W	K0
1218	2.80±0.20	4.60±0.20	1.50±0.10	5.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	12.0±0.10	0.75±0.10
1812	3.52±0.10	5.10±0.10	1.50±0.10	5.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	12.0±0.10	0.78±0.10
2010	2.75±0.10	5.40±0.10	1.50±0.10	5.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	12.0±0.10	0.75±0.10
2512	3.35±0.10	6.70±0.10	1.50±0.10	5.50±0.05	4.00±0.10	4.00±0.10	2.00±0.05	12.0±0.10	0.75±0.10

■ 上胶带剥离力测试 (Peel force of top cover tape)

上胶带以 200mm/分钟的速度, 沿 165~180 度角的方向进行剥离, 如下图所示。纸带的剥离力范为 10g~70g;
载带的剥离力范围 30~100g。

The top cover tape is pulled at a speed of 200 mm/min with the angle between the tape during peel and the direction of

unreeling maintained at 165 to 180 degree as following picture. The peel force of paper carrier tape shall be 0.1N to 0.7N(10 to 70 g), the peel force of plastic carrier tape shall be 0.3N to 1N (30 to 100 g)



■ 厚膜电阻器使用说明 (Chip Resistor Instructions for use)

本产品以下特殊环境下应用，性能可能会受到影响：

(Application of the products in a special environment can deteriorate product performance) :

1. 高温；
High temperature
2. 有海风或腐蚀性气体，包括氯气，硫化氢，氨气，二氧化硫，二氧化氮等；
Near the sea ,or corrosive gas, such as Cl_2 , H_2S , NH_3 , SO_2 , and NO_2 , etc;
3. 各种类型的液体，包括水，油，化学品，有机溶剂的使用；
Unverified liquids, such as water, oil, chemical or organic solvent;
4. 在用树脂或其他涂层材料密封产品的情况下使用；
Unverified resin or paint to cover products;
5. 焊接后使用不洁焊剂或使用水或水溶性清洁剂清洗产品
Products should be washed with soluble cleaner even if non cleaning flux.

- 储存 / 搬运条件 (Storage / Carry conditions)

1. 储存温度 $25 \pm 5^\circ\text{C}$ Temperature: $25 \pm 5^\circ\text{C}$
2. 湿度 30~70%RH Humidity: 30~70%RH
3. 储存期限：先进先出，2 年 Storage life: 2years FIFO
4. 存放和搬运时，请保持盒子的正确方向。严禁跌落在箱体上，否则可能损坏产品电极或本体
Please hold box correct orientation when storing and carrying. It is strictly prohibited to fall on the box.
otherwise the product electrode or body may be damaged.

[illegible]

